WPFxxAxH Series (Rev:G)

1. Features

- Halogen free;
- SMD Electronic devices;
- High structural intensity;
- Over current protection ;
- Over charge protection;
- Compatible with reflow soldering processes
- UL: UL-248-1,UL-248-14….File Number: E311435
- TUV: EN60127-1,EN60127-4…File Number:J50552619

2. Environmental Characteristics

Specifications are subject to change without notice

(1) Contents of halogens used in each material for the product are as follows.

Halogen substance	Content
Chlorine (CL)	≤ 900ppm (0.09%)
Bromine (Br)	≤ 900ppm (0.09%)
Total concentration of	≤ 1500ppm (0.15%)
chlorine (CI) + bromine (Br)	

(2) The product described in this specification complies with the RoHS Directive. BOM table contains the high-temperature alloy, solder, some electronic slurry, including lead, but are in line with the relevant provisions of the ROHS directive.

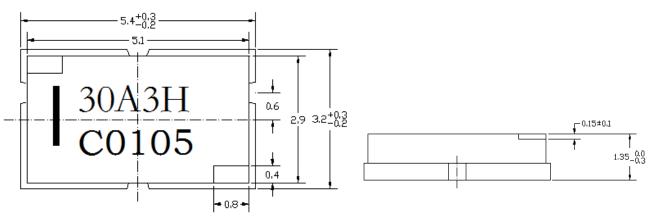




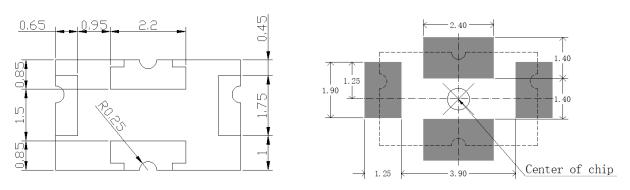
Rev.G.) Surf:

3. Dimensions and Circuit Chart

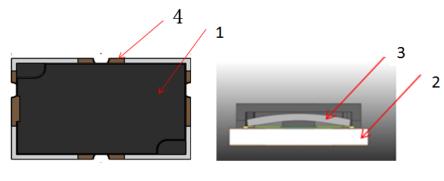
3.1 Dimensions



Unit: mm Tolerances Unless Otherwise Specified: ±0.2mm



3.2 Construction



Тор

Cross section

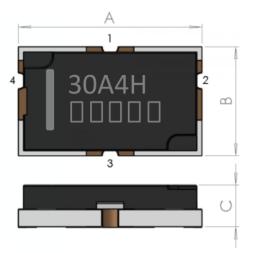
Note: The top cover of the product shown in the figure does not distinguish between the right and the left.

No.	Name	Material
1	Сар	LCP
2	Ceramic	AI2O3
3	Alloy	Sn/Pb/Ag
4	Termination electrode	Ag/Pd/Ni/Au

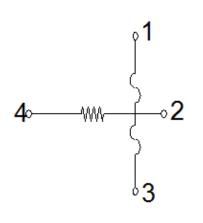


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3.3 Circuit Chart

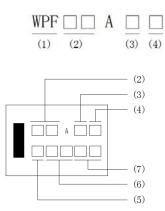


Product Dimensions



Equivalent Circuit

4. Marking requirements



- (1) WPF: SCF/Way-on SCF protector;
- (2) Rated current: 12A,15A,30A;
- (3) Commercial Code;
- (4) Length width size code;H:5.4×3.2mm;
- (5) Year: H: 2022; I: 2023; J: 2024; K: 2025; L: 2026; M: 2027.....;
- (6) Week of year: 01、02.....52;
- (7) Running number: 01、02.....;

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5. Specifications

Part Number	Rated current	Rated voltage ★	Operating Voltage	Fuse DCR (1)	Heater DCR (2)	Breaking capacity	Applicable Cells in series
	Α	VDC	V	mΩ	Ω	Α	cell
WPF12A1H	12	62	4.0-7.0	1.5-3.5	1.5-3.5	50	1
WPF12A2H	12	62	4.0-9.0	1.5-3.5	1.8-3.2	50	2
WPF12A3H	12	62	7.4-13.8	1.5-3.5	5.5-9.1	50	3
WPF12A4H	12	62	10.5-19.6	1.5-3.5	11.0-18.4	50	4
WPF12A5H	12	62	14.4-23.5	1.5-3.5	19.0-30.0	50	5
WPF12A5H-3	12	62	17.4-32.9	1.5-3.5	31.0-50.0	50	6-7
WPF12A5H-10	12	62	42-62.0	1.5-3.5	120.0-220.0	50	14
			1	1	1		
WPF15A3H	15	62	7.4-13.8	1.0-3.0	5.5-8.3	50	3
WPF15A4H	15	62	10.5-19.6	1.0-3.0	11.0-17.0	50	4
WPF15A5H	15	62	14.4-23.5	1.0-3.0	17.9-29.1	50	5
WPF15A5H-3	15	62	17.4-32.9	1.0-3.0	31.0-46.5	50	6-7
WPF15A5H-10	15	62	49.0-62.0	1.0-3.0	130.0-195.0	50	13-14
WPF30A1H	30	62	4.0-4.7	0.5-2.5	1.0-1.5	80	1
WPF30A2H	30	62	6.6-9.0	0.5-2.5	1.8-3.1	80	2
WPF30A3H	30	62	9.9-13.5	0.5-2.5	4.2-7.1	80	3
WPF30A4H	30	62	13.4-18.4	0.5-2.5	7.7-12.9	80	4
WPF30A5H	30	62	17.1-23.5	0.5-2.5	12.6-21.0	80	5
WPF30A7H-3	30	62	19.8-27.6	0.5-2.5	17.4-28.0	80	6
WPF30A7H	30	62	23.0-31.5	0.5-2.5	22.6-37.7	80	6-7
WPF30A7H-2	30	62	26.5-36.0	0.5-2.5	31.0-47.0	80	7-8
WPF30A10H	30	62	34.2-46.9	0.5-2.5	63.75-86.25	80	9-10
WPF30A14H	30	62	45.2-62.0	0.5-2.5	109.9-170.3	80	12-14
WPF30A14H-3P	30	62	40.0-60.0	0.5-2.5	78.0-120.0	80	15-16 LFP

 \star Rated voltage is the maximum voltage that the fuse can block, not the action voltage of the heater assembly.

6. Clear-Time Characteristics

Test Item	Condition of Test	requirement at 25℃
Carrying Capacity (UL248-14)	100% of rated current, 4hr	No Melting
Fusing Time	200% rated Current	≪1min
(UL248-14)	In operation voltage range	

Operating temperature range: -10~65℃ (Fusing time≤1min)

Electrical Characteristics is influenced by thermal capacity of PCB, parts, pattern width, and so on. Therefore you should check it on your PCB.

7. Standard test condition

In the absence of additional test environmental standards, the test environmental standards are as follows;

Ambient temperature: 5 to 35℃;

Relative humidity: 45 to 85%RH; Air

pressure: 86 to 106kPa.

If you have any questions about the test results, please follow the following environmental standards;

Ambient temperature: 20±2℃;

Relative humidity: 60 to 70%RH; Air

pressure: 86 to 106kPa.

8. Reliability

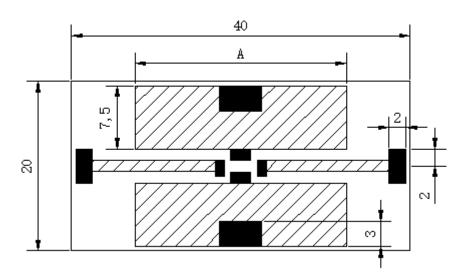
Project	Condition	Requirements
Over voltage		Fusing Time≪1min
Insulation		>0.2MΩ
Withstand	@100VAC @50-60Hz@60s after OV	No breakdown
voltage	operating voltage test	NO DIEAKOOWI
Over current	200% of Rated current	Fusing Time≤1min
Carrying Capacity	100% of rated current, 4hr	No Melting
High temperature	100°C±5°C@250hr	Without deformation of
High humidity	60°C±2°C@90%~95%@250hr	case or excessive looseness of caps.
Keeping cold	-20°C±3°C @ 500hr	Electrical characteristics shall be satisfied.
Pulse	5×In(In = rated current)A @ 25℃ @on 5ms/off 995 ms,100,000 cycles	No operating;
	Solder: Pb-free (Sn96.5/Ag3/Cu0.5[%])	A manual if a manual time of
		A new uniform coating of solder shall cover a
Solder ability		minimum of 95% of the
	·	surface being immersed.
	•	
	·	
		Without deformation of
Resistance to	•	case or excessive
soldering heat	•	looseness of caps. Electrical characteristics
	•	shall be satisfied.
	•	
	•	
	•	
	Insulation Withstand voltage Over current Carrying Capacity High temperature High humidity Keeping cold Pulse Solder ability	Over voltageOperating voltage shall be applied to heaterInsulation@100VDC after OV operating voltage testWithstand voltage@100VAC @50-60Hz@60s after OV operating voltage testOver current200% of Rated currentCarrying Capacity100% of rated current, 4hrHigh temperature100°C±5°C@250hrHigh humidity60°C±2°C@90%~95%@250hrKeeping cold-20°C±3°C @ 500hrPulse5×In (In = rated current) A @ 25°C @on 5ms/off 995 ms, 100,000 cyclesSolder abilitySolder: Pb-free (Sn96.5/Ag3/Cu0.5[%])Flux: 25wt%Rosin Ethanol solutionDipping depth: 2~2.5mm Temperature: 245±5°CDipping time: 3±0.5sDipping time: 3±0.5sDipping and drawing speed: 25±2.5mm/s(1) Reflow soldering method Peak temp: 255°C±5°C 5s 230°C±5°C 30sAt electrode temperature of the specimen. (Solder temperature)The specimen shall be passed through the reflow furnace with the condition shown in the above profile for 2times.Resistance to solderingThe specimen shall be stored at standard



Electrical Characteristics is influenced by thermal capacity of PCB, parts, pattern width, and so on.

Therefore you should check it on your PCB.

9. Recommended Solder Pad Dimensio



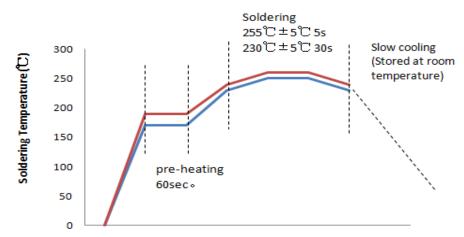
Unit: mm

Туре	Materials	Copper width A	Base thickness	Copper	Covered wires
12A	FR-4	2mm	0.6 mm	2.00Z	AWG18
15A	FR-4	3.5mm	0.6 mm	2.00Z	AWG18
30A	FR-4	25mm	0.6 mm	2.00Z	AWG10

When the patch on the PCB board printed solder paste steel mesh thickness is best not more than

0.12 mm.

10. Solder Reflow Recommendations



Reflow soldering method:

Peak temp: $255^{\circ}C \pm 5^{\circ}C$ 5s, $230^{\circ}C \pm 5^{\circ}C$ 30s. The specimen shall be passed through the reflow furnace for 2times.

Specifications are subject to change without notice

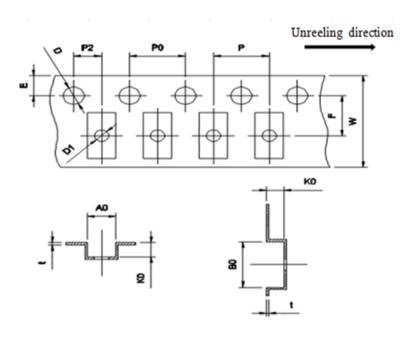
Wayon Electronics Co.,Ltd. Tel: 86-21- 50968308 No.1001, Shiwan 7th Road, Pudong Area, Shanghai 201202,China E-mail: market@way-on.com Http://www.way-on.com Page 7 of 10

11. Packaging Data

Package form is embossed tape packing.

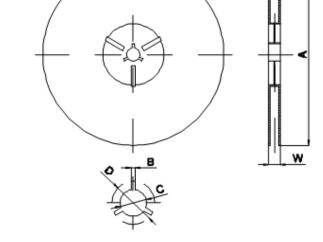
11.1 Dimension of Tape and Reels

Code	(mm)
E	1.75±0.10
F	5.50±0.10
P2	2.00±0.1
D	1.50+0.1/-0
D1	1.50+0.1/-0
P0	4.00±0.10
10P0	40.0±0.20
W	12.00±0.30
Р	8.00±0.10
A0	3.80±0.10
B0	5.6±0.10
K0	1.5±0.10
t	0.30±0.05



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Code	(mm)
А	330±1.0
В	2+0.5/-0
С	13±0.2
D	21±0.2
W	15.4±0.5



11.2 Packing Quantity

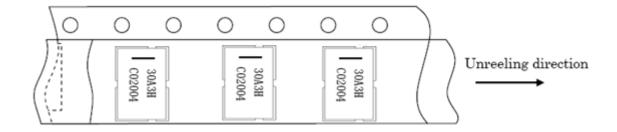
5000 pcs /reel.

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11.3 Direction of Taping

The direction shall be seen from the top cover tape side.



11.4 Label (example)

The label contains the following content:

- (1) manufacturer of trademark and factory address,
- (2) product type,
- (3) product batch number,
- (4) quantity,
- (5) shipment inspection personnel quality code,
- (6) date of shipment,
- (7) the certification mark.

	wan 7th Road, Sh	hanghai, 201202 P.R. China
WPF30A14H P/N:		HF
RC1941		GREEN
Qty:	E F.V.LWAR	PRODUCT RoHS
QC: 0QC13		c AL us
ID: 021701000000047	STORES	DATE: 2020-03-19

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12. Storage

The product must be stored in carton or plastic bag, in the conditions of ambient temperature of -10° C to 40° C, RH of less than 60%, no radical temperature change, no direct sunshine, excessive vibration and shock.

The preservation period when it is kept on the above condition is 1 year.

Should avoid to store at where there is possibility of generating corrosive gas, such as salt mist, chlorine, hydrogen sulfide, ammonium, sulfide-oxidation, hydrogen chloride, etc.

13. Cautions

(1)Can predict, the heat capacity of the test board current carrying capacity of a heater to work with the use of the relevant characteristics, therefore, before use to check the test board PCB you use, generally PCB plate heat capacity is bigger, the longer the action.

(2)The data referred to in this specification are tested under the PCB standard of UL(0.6t Glass Epoxy single-sided copper laminated), The characteristics influenced thermal capacity of PCB, on the machine before using the PCB to do the actual test to confirm the by.

(3) Ultrasonic-cleaning or immersion-cleaning and so on must not be done to SCF before and after mounted. When cleaning is done, flux on element would flow, and it would not be satisfied.

its specification. Moreover, a similar influence happens when the product comes in contact with cleaningsolution. These products after cleaning will not be guaranteed.

(4)This product can not be used in resin packaging, packaging process of resin into the product, resulting in poor product performance.

(5)Please do not re-use of the product removed by the solder correction.

(6)Please confirm the connection with the three terminal circuit board , where in 1-4, 3-4 is used as a heating end with high resistance.

(7)This product is designed and used in conventional electronic devices, so we do not recommend the use of military, medical and other areas of other people and property may cause direct damage.

(8) If there is any doubt or change in the contents of this book, please inform us in advance so that both parties can reach an agreement.